ASSOCIATION CONNECTINI ELECTRONICS INDUSTRIES	© Copyright 2005. IPC, international and Pan-Ar	Bannockb	urn, Illinois. A	ll rights reserved untions.	under both	This docum level parts, t	ent is a declara the declaration	tion of the encompass	substance ses all low	s within the er level mate	manufactur erials for wl	er listed it hich the m	em. Note: anufacture	if the item is an as er has engineering	sembly with lower responsibility.
1752-21.1	IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute				*	* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi					als and Mfg Information				
Supplier Inform	ation														
Company name*			Company unique ID				Unique ID Authority					Response Date*			
onsemi												2025-06-06			
Contact Name			Title - Contact				Phone - Contact*				Email - Contact*				
Product-Env-Stewards			Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com				
Authorized Representative*			Title - Representative				Phone - Representative*				Email - Representative*				
Product-Env-Stewards			Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com				
Requeste	Requester Item Number Mfr Item		n Number Mfr Item Name				Effective Dat	Date Version Manufacturing Site		V	Veight*	UOM	Unit Type		
		NCV51200MWTXG 3A DI		3A DDR / VTT 1	A DDR / VTT TERMINATION		2025-06-06					2	4.66	mg	Each
Manufacturing	Proccess Information	1						-							
Terminal Plating / Grid Array Material Termi			erminal Base A	inal Base Alloy J-STD-020 MSL		L Rating	Peak Process Body Temperature		ure Max Ti	ne at Peak	k Temperature Number of		ber of Reflow Cyc	cles	
Matte Tin (Sn) - annealed CU Alloy			U Alloy		1		260		C	30		second	is 3		
Comments															
evel 1 - maximum ti	me at peak temperature o	luring sol	dering is 10-3	0 seconds											
For more information	on regarding material con	position <b>j</b>	please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed
Directive 2015/863/EU amending RoHS Directive 2011/65/EU		nium (Cr6+), Polybro	ominated Biphenyls (PBB), Polybron	dmium and quantity limit of 0.1% by mass (100 minated Diphenyl Ethers (PBDE), and Bis(2-eth	
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all
Exemption List Version	EL-2011/534/EU				
Declaration Signature					
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the
Supplier Digital Signature Ra	stislav Drska	Le			

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

	cable [E] enter the weigh			ance category (JIG or Requester) or en [F] Optionally enter the positive (+) a				
Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.64	mg	Supplier	Silicon (Si)	7440-21-3		0.64	mg
Die Attach	0.11	mg	Supplier	Silver (Ag)	7440-22-4		0.0825	mg
			Supplier	Epoxy resins	129915-35-1		0.0275	mg
Lead Frame	10.69	mg	Supplier	Silver (Ag)	7440-22-4		0.1069	mg
			Supplier	Tin (Sn)	7440-31-5		0.0267	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0235	mg
			Supplier	Chromium (Cr)	7440-47-3		0.0267	mg
			Supplier	Copper (Cu)	7440-50-8		10.5061	mg
Mold Compound-Black	12.39	mg		Epoxy resin	proprietary data		0.5823	mg
			Supplier	Phenol Resin	Proprietary Data		0.5823	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0124	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		11.2129	mg
Plating	0.56	mg	Supplier	Tin (Sn)	7440-31-5		0.56	mg
Wire Bond - Au	0.27	mg	Supplier	Gold (Au)	7440-57-5		0.27	mg